## **IN THE CLAIMS**

Please amend the claims as follows:

Claims 1-17 (Canceled).

Claim 18 (New): A calixresorcinarene compound shown by formula (1),

$$RO$$
 $H_3C$ 
 $CH_3$ 
 $CH$ 

wherein R individually represents a hydrogen atom, a 1-tetrahydropyranyl group, a 1-tetrahydrofuranyl group, or one or more organic groups selected from the group consisting of the organic groups shown by the following formulas,

wherein n individually represents an integer of 1 to 50,

provided that a compound in which R is selected only from a hydrogen atom, a 1-tetrahydropyranyl group, and a 1-tetrahydrofuranyl group is excluded.

Claim 19 (New): A method for the purification of a calixresorcinarene compound according to claim 18 comprising washing said compound with an acidic aqueous solution and processing the washed compound with an ion-exchange resin.

Claim 20 (New): A photoresist base material for extreme ultraviolet radiation and/or an electron beam comprising the calixresorcinarene compound according to claim 18 and shown by formula (1).

Claim 21 (New): A photoresist composition for extreme ultraviolet radiation and/or an electron beam comprising the photoresist base material according to claim 20 and a solvent.

Claim 22 (New): The photoresist composition according to claim 21, further comprising a photoacid generator.

Claim 23 (New): The photoresist composition according to claim 21, further comprising a basic organic compound as a quenching agent.

Claim 24 (New): A photoresist composition comprising a photoresist base material that is an extreme ultraviolet radiation-reactive organic compound shown by formula (2), obtained by washing with an acidic aqueous solution and processing with an ion-exchange resin, a photoacid generator or a photobase generator, and a quenching agent,

$$\begin{pmatrix}
C
\end{pmatrix}_{m}
\begin{pmatrix}
C
\end{pmatrix}_{m}
\begin{pmatrix}
C
\end{pmatrix}_{n}$$
(2)

wherein A is an organic group represented by one of the following formulas,

B, C, and D are individually a group reactive with extreme ultraviolet radiation, a group reactive with an effect of a chromophore active to extreme ultraviolet radiation, or an organic group of any of the following formulas,

$$Ar$$
  $Ar$   $Ar$   $Ar$   $Ar$   $Ar$   $Ar$ 

wherein Ar is a phenyl group or a naphthyl group substituted with RO- and/or ROCO-, wherein R, RO-, and ROCO- are groups reactive with extreme ultraviolet radiation or groups reactive with an effect of a chromophore active to extreme ultraviolet radiation, and

X, Y, and Z individually represent a single bond or an ether bond, and 1 + m + n = 2, 3, 4, or 8.

Claim 25 (New): The photoresist composition according to claim 24, wherein the extreme ultraviolet-radiation reactive organic compound is in an amorphous state at room temperature and the average diameter of the molecule is 2 nm or less.

Claim 26 (New): The photoresist composition according to claim 24, wherein A is an organic group represented by any of the following formulas,

B, C, and D are individually a hydrogen atom, a tert-butyl group, tert-butyloxycarbonylmethyl group, tert-butyloxycarbonyl group, 1-tetrahydropyranyl group, 1-tetrahydrofuranyl group, 1-ethoxyethyl group, 1-phenoxyethyl group, an organic group shown by the formula,

$$\frac{-\left(\begin{array}{c}H_2\\C\end{array}\right)_{S}P-\left(\begin{array}{c}O\\O-C\\O-Q\end{array}\right)_{\Gamma}$$

wherein P is an aromatic group having 6 to 20 carbon atoms with a valence of (r + 1), Q represents an organic group having 4 to 30 carbon atoms, r is an integer of 1 to 10, and s is an integer of 0 to 10, or an organic group represented by any of the following formulas,

$$Ar - CH_2 - Ar -$$

wherein Ar is a phenyl group or a naphthyl group substituted with RO- and/or ROCO-, wherein R is a hydrogen atom, a tert-butyl group, tert-butyloxycarbonylmethyl group, tert-butyloxycarbonyl group, 1-tetrahydropyranyl group, 1-tetrahydrofuranyl group, 1-

ethoxyethyl group, 1-phenoxyethyl group, or an organic group shown by the following formula,

$$-\left(\begin{matrix} H_2 \\ C \end{matrix}\right)_S P - \left(\begin{matrix} O \\ O - C - O - Q \end{matrix}\right)_T$$

wherein P is an aromatic group having 6 to 20 carbon atoms with a valence of (r + 1), Q represents an organic group having 4 to 30 carbon atoms, r is an integer of 1 to 10, and s is an integer of 0 to 10, and

X, Y, and Z individually represent a single bond or an ether bond.

Claim 27 (New): The photoresist composition according to claim 24, wherein A is any one of the organic groups represented by the following formulas,

B, C, and D are individually a hydrogen atom, a tert-butyl group, tert-butyloxycarbonylmethyl group, tert-butyloxycarbonyl group, 1-tetrahydropyranyl group, 1-tetrahydrofuranyl group, 1-ethoxyethyl group, 1-phenoxyethyl group, or an organic group shown by the following formula,

$$-\left(\begin{matrix} H_2 \\ C \end{matrix}\right)_S P - \left(\begin{matrix} O \\ O \end{matrix}\right)_C - O - Q \\ 0 \end{matrix}\right)_r$$

wherein P is an aromatic group having 6 to 20 carbon atoms with a valence of (r + 1), Q represents an organic group having 4 to 30 carbon atoms, r is an integer of 1 to 10, and s is an integer of 0 to 10, and

X, Y, and Z are ether bonds.

Claim 28 (New): A photoresist composition comprising a photoresist base material that is a radiation-reactive organic compound shown by formula (2), obtained by washing with an acidic aqueous solution and processing with an ion-exchange resin, a photoacid generator or a photobase generator, and a quenching agent,

wherein A is an organic group represented by one of the following formulas,

B, C, and D are individually a tert-butyloxycarbonylmethyl group, tertbutyloxycarbonyl group, or an organic group shown by formula,

$$-\left(-\frac{H_2}{C}\right)_S P - \left(-O - \frac{O}{C} - O - Q\right)_T$$

wherein P is an aromatic group having 6 to 20 carbon atoms with a valence of (r + 1), Q represents an organic group having 4 to 30 carbon atoms, r is an integer of 1 to 10, and s is an integer of 0 to 10, and

X, Y, and Z individually represent a single bond or an ether bond, and 1 + m + n = 3 or 8.

Claim 29 (New): The photoresist composition according to claim 28, wherein the organic group shown by the following formula,

$$\frac{-\left(\begin{array}{c}H_2\\C\end{array}\right)}{-\left(\begin{array}{c}C\\C\end{array}\right)}P-\left(\begin{array}{c}O\\C\\C\end{array}\right)-\left(\begin{array}{c}O\\C\\C\end{array}\right)$$

is a 4-(tert-butoxycarbonyloxy)benzyl group or a 3,5-di(tert-butoxycarbonyloxy)benzyl group.

Claim 30 (New): The photoresist composition according to claim 28, wherein the radiation is extreme ultraviolet radiation or an electron beam.

Claim 31 (New): The photoresist composition according to claim 24, wherein at least one of B, C, and D is a hydrogen atom and X, Y, and Z are ether bonds.

Claim 32 (New): The photoresist composition according to claim 24, wherein the basic impurity content of the photoresist base material is not more than 10 ppm.

Claim 33 (New): A method for microfabrication by lithography using the photoresist composition according to claim 21.

Claim 34 (New): A semiconductor device prepared using the photoresist composition according to claim 21.